Preferred Devices

Dual Common Base-Collector Bias Resistor Transistors

NPN and PNP Silicon Surface Mount Transistors with Monolithic Bias Resistor Network

The BRT (Bias Resistor Transistor) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base–emitter resistor. These digital transistors are designed to replace a single device and its external resistor bias network. The BRT eliminates these individual components by integrating them into a single device. In the NSTB1002DXV5T1G series, two complementary devices are housed in the SOT–553 package which is ideal for low power surface mount applications where board space is at a premium.

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- Available in 8 mm, 7 inch Tape and Reel
- These are Pb-Free Devices

MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted, common for Q_1 and Q_2 , – minus sign for Q_1 (PNP) omitted)

		Value		
Rating	Symbol	Q1	Q2	Unit
Collector-Base Voltage	V _{CBO}	-40	50	Vdc
Collector-Emitter Voltage	V _{CEO}	-40	50	Vdc
Collector Current	Ic	-200	100	mAdc

THERMAL CHARACTERISTICS

Characteristic (One Junction Heated)	Symbol	Max	Unit
(One varietion fleated)	Syllibol	IVIAX	Ollit
Total Device Dissipation T _A = 25°C Derate above 25°C	P _D	357 (Note 1) 2.9 (Note 1)	mW mW/°C
Thermal Resistance – Junction-to-Ambient	$R_{\theta JA}$	350 (Note 1)	°C/W
Characteristic			
(Both Junctions Heated)	Symbol	Max	Unit
Total Device Dissipation T _A = 25°C	P_{D}	500 (Note 1)	mW
Derate above 25°C		4.0 (Note 1)	mW/°C
Thermal Resistance – Junction-to-Ambient	R _{θJA}	4.0 (Note 1) 250 (Note 1)	mW/°C °C/W

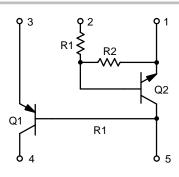
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. FR-4 @ Minimum Pad



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MARKING DIAGRAM



U9 = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping
NSTB1002DXV5T1G		4 mm pitch 4000/Tape & Reel
NSTB1002DXV5T5G	SOT-553 (Pb-Free)	2 mm pitch 8000/Tape & Reel

Preferred devices are recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Q1 TRANSISTOR: PNP OFF CHARACTERISTICS					
Collector - Emitter Breakdown Voltage (Note	2)	V _{(BR)CEO}	-40	_	Vdc
Collector - Base Breakdown Voltage		V _{(BR)CBO}	-40	-	Vdc
Emitter – Base Breakdown Voltage		V _{(BR)EBO}	-5.0	-	Vdc
Base Cutoff Current		I _{BL}	-	-50	nAdc
Collector Cutoff Current		I _{CEX}	_	-50	nAdc
ON CHARACTERISTICS (Note 2)				•	•
DC Current Gain $ \begin{array}{l} \text{(I}_{C} = -0.1 \text{ mAdc, V}_{CE} = -1.0 \text{ Vdc)} \\ \text{(I}_{C} = -1.0 \text{ mAdc, V}_{CE} = -1.0 \text{ Vdc)} \\ \text{(I}_{C} = -1.0 \text{ mAdc, V}_{CE} = -1.0 \text{ Vdc)} \\ \text{(I}_{C} = -10 \text{ mAdc, V}_{CE} = -1.0 \text{ Vdc)} \\ \text{(I}_{C} = -50 \text{ mAdc, V}_{CE} = -1.0 \text{ Vdc)} \\ \text{(I}_{C} = -100 \text{ mAdc, V}_{CE} = -1.0 \text{ Vdc)} \end{array} $		h _{FE}	60 80 100 60 30	- 300 - -	-
		V _{CE(sat)}	<u>-</u>	-0.25 -0.4	Vdc
Base – Emitter Saturation Voltage ($I_C = -10$ mAdc, $I_B = -1.0$ mAdc) ($I_C = -50$ mAdc, $I_B = -5.0$ mAdc)		V _{BE(sat)}	-0.65 -	-0.85 -0.95	Vdc
SMALL-SIGNAL CHARACTERISTICS					
Current-Gain - Bandwidth Product		f _T	250	-	MHz
Output Capacitance		C _{obo}	-	4.5	pF
Input Capacitance		C _{ibo}	-	10.0	pF
Input Impedance ($V_{CE} = -10 \text{ Vdc}$, $I_{C} = -1.0 \text{ mAdc}$, $f = 1.0$	kHz)	h _{ie}	2.0	12	kΩ
Voltage Feedback Ratio $(V_{CE} = -10 \text{ Vdc}, I_{C} = -1.0 \text{ mAdc}, f = 1.0$	kHz)	h _{re}	0.1	10	X 10 ⁻⁴
Small – Signal Current Gain (V _{CE} = -10 Vdc, I _C = -1.0 mAdc, f = 1.0	kHz)	h _{fe}	100	400	-
Output Admittance $(V_{CE} = -10 \text{ Vdc}, I_C = -1.0 \text{ mAdc}, f = 1.0$	kHz)	h _{oe}	3.0	60	μmhos
Noise Figure ($V_{CE} = -5.0 \text{ Vdc}$, $I_{C} = -100 \mu\text{Adc}$, $R_{S} = 1$.0 kΩ, f = 1.0 kHz)	nF	-	4.0	dB
SWITCHING CHARACTERISTICS					
Delay Time	$(V_{CC} = -3.0 \text{ Vdc}, V_{BE} = 0.5 \text{ Vdc})$	t _d	-	35	ne
Rise Time	$(I_C = -10 \text{ mAdc}, I_{B1} = -1.0 \text{ mAdc})$	t _r	-	35	ns
Storage Time	$(V_{CC} = -3.0 \text{ Vdc}, I_{C} = -10 \text{ mAdc})$	t _s	-	225	no
Fall Time	$(I_{B1} = I_{B2} = -1.0 \text{ mAdc})$	t _f	-	75	ns
Q2 TRANSISTOR: NPN OFF CHARACTERISTICS					
Collector-Base Cutoff Current (V _{CB} = 50 V, I _E = 0)	I _{CBO}	-	-	100	nAdc
Collector-Emitter Cutoff Current (V _{CB} = 50 V, I _B = 0)	I _{CEO}	-	-	500	nAdc
	1		 	i –	

^{2.} Pulse Test: Pulse Width $\leq 300~\mu s;$ Duty Cycle $\leq 2.0\%.$

 $\textbf{ELECTRICAL CHARACTERISTICS} \ (T_A = 25^{\circ}C \ unless \ otherwise \ noted)$

Characteristic	Symbol	Min	Тур	Max	Unit
ON CHARACTERISTICS		,	1		
Collector-Base Breakdown Voltage (I _C = 10 μA, I _E = 0)	V _(BR) CBO	50	_	_	Vdc
Collector-Emitter Breakdown Voltage (I _C = 2.0 mA, I _B = 0)	V _{(BR)CEO}	50	-	_	Vdc
DC Current Gain (V _{CE} = 10 V, I _C = 5.0 mA)	h _{FE}	80	140	-	
Collector–Emitter Saturation Voltage (I _C = 10 mA, I _B = 0.3 mA)	V _{CE(SAT)}	-	-	0.25	Vdc
Output Voltage (on) $(V_{CC} = 5.0 \text{ V}, V_B = 2.5 \text{ V}, R_L = 1.0 \text{ k}\Omega)$	V _{OL}	-	-	0.2	Vdc
Output Voltage (off) ($V_{CC} = 5.0 \text{ V}, V_B = 0.5 \text{ V}, R_L = 1.0 \text{ k}\Omega$)	V _{OH}	4.9	_	_	Vdc
Input Resistor	R1	33	47	61	kΩ
Resistor Ratio	R1/R2	0.8	1.0	1.2	

^{2.} Pulse Test: Pulse Width \leq 300 μ s; Duty Cycle \leq 2.0%.

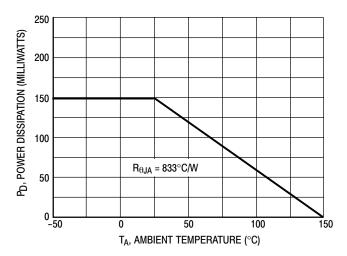


Figure 1. Derating Curve

TYPICAL ELECTRICAL CHARACTERISTICS — PNP TRANSISTOR

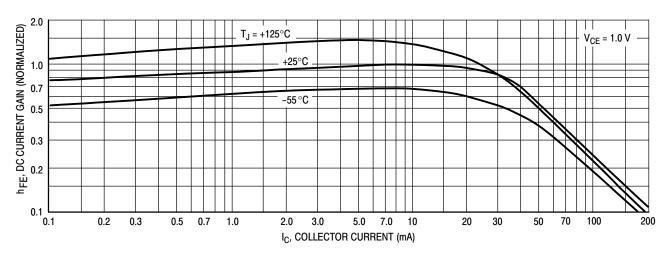


Figure 2. DC Current Gain

TYPICAL ELECTRICAL CHARACTERISTICS — NPN TRANSISTOR

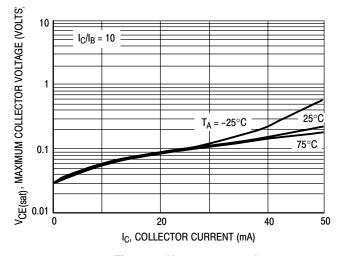


Figure 3. V_{CE(sat)} versus I_C

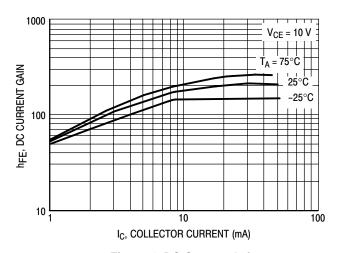


Figure 4. DC Current Gain

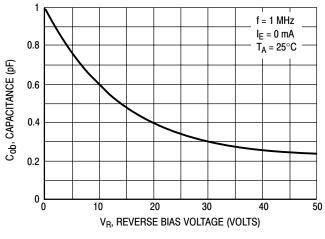


Figure 5. Output Capacitance

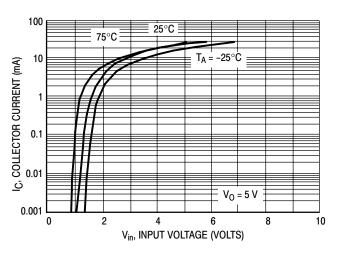


Figure 6. Output Current versus Input Voltage

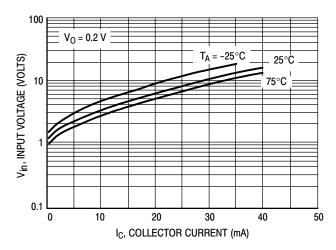
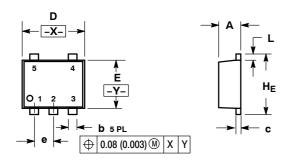


Figure 7. Input Voltage versus Output Current

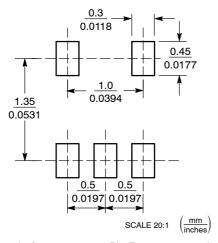


SOT-553, 5 LEAD CASE 463B ISSUE C

DATE 20 MAR 2013



RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: MILLIMETERS

 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH
 THICKNESS: MINIMUM LEAD THICKNESS IS THE MINIMUM
 THICKNESS OF BASE MATERIAL.

	MILLIMETERS				INCHES	
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.50	0.55	0.60	0.020	0.022	0.024
b	0.17	0.22	0.27	0.007	0.009	0.011
С	0.08	0.13	0.18	0.003	0.005	0.007
D	1.55	1.60	1.65	0.061	0.063	0.065
E	1.15	1.20	1.25	0.045	0.047	0.049
е		0.50 BSC		0.020 BSC		
L	0.10	0.20	0.30	0.004	0.008	0.012
HE	1.55	1.60	1.65	0.061	0.063	0.065

GENERIC MARKING DIAGRAM*



XX = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

STYLE 1:	STYLE 2:	STYLE 3:	STYLE 4:	STYLE 5:
PIN 1. BASE	PIN 1. CATHODE	PIN 1. ANODE 1	PIN 1. SOURCE 1	PIN 1. ANODE
2. EMITTER	2. COMMON ANODE	2. N/C	2. DRAIN 1/2	2. EMITTER
3. BASE	CATHODE 2	3. ANODE 2	SOURCE 1	3. BASE
4. COLLECTOR	CATHODE 3	CATHODE 2	4. GATE 1	4. COLLECTOR
COLLECTOR	CATHODE 4	CATHODE 1	5. GATE 2	CATHODE
STYLE 6: PIN 1. EMITTER 2 2. BASE 2 3. EMITTER 1 4. COLLECTOR 1 5. COLLECTOR 2/BASE 1	STYLE 7: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 5. COLLECTOR	STYLE 8: PIN 1. CATHODE 2. COLLECTOR 3. N/C 4. BASE 5. EMITTER	STYLE 9: PIN 1. ANODE 2. CATHODE 3. ANODE 4. ANODE 5. ANODE	

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PAGE 2 OF 2

ISSUE	REVISION	DATE
Α	ADDED STYLES 3-9. REQ. BY D. BARLOW	11 NOV 2003
В	ADDED NOMINAL VALUES AND UPDATED GENERIC MARKING DIAGRAM. REQ. BY HONG XIAO	27 MAY 2005
С	UPDATED DIMENSIONS D, E, AND HE. REQ. BY J. LETTERMAN.	20 MAR 2013

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